

A

B

C

D

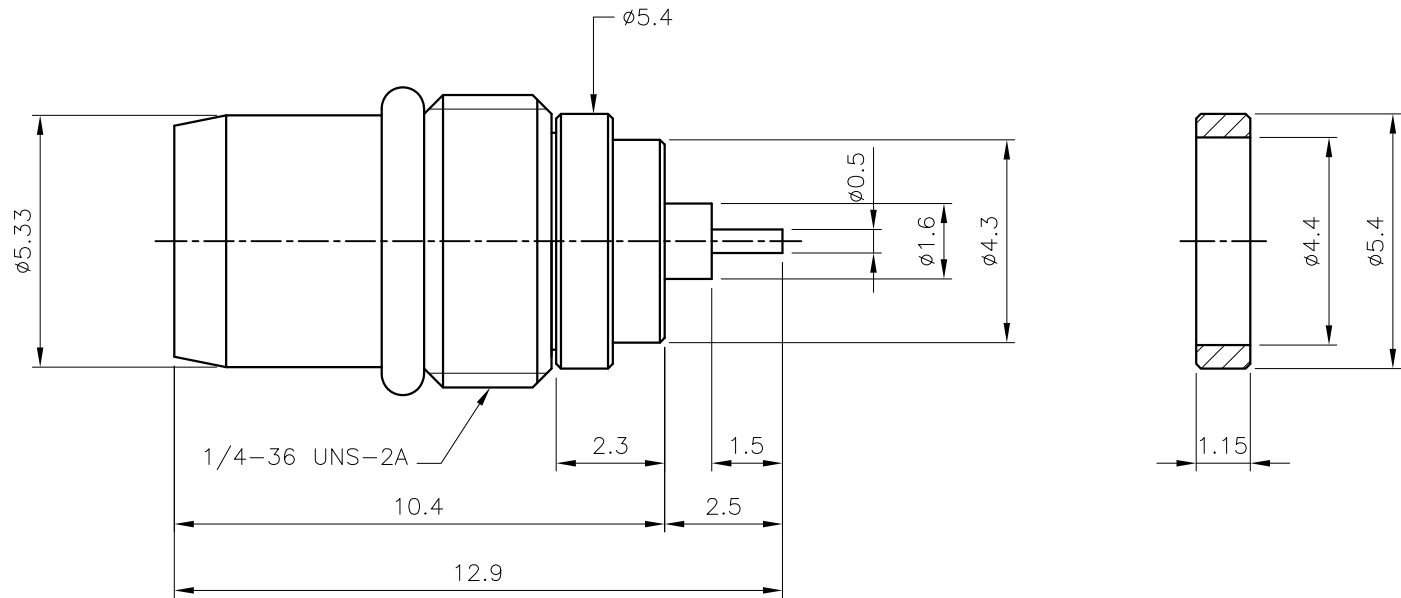
A

B

C

D

REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2024.01.19.



6	METALLIC GASKET	1	AL6061	Silver Plate (5 μ m)	DSR01210-5/1
5	INSULATOR		TEFLON		DIN03384-N/1
4	GASKET	1	SILICONE RUB		DGK00017-N/2
3	CONTACT	1	MBsBD C3604BD-F	Gold Plate (1.27 μ m)	DCT04415-5/1
2	BODY (B)	1	MBsBD C3604BD-F	Gold Plate	DBD04927-5/1
1	BODY (A)	1	SUS303	SUCO Plate	DBD04926-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2024. 01. 19.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017 KJ COMTECH CO.,LTD.		
	Angle ±1°	APPROVED BY					
MATERIAL _____		CHECKED BY			TITLE BMA50 SOLDER END PB(R/N)		
		DRAWN BY S.H.KIM					
FINISH _____		SCALE 6/1	UNIT mm		A4	DWG NO. CN04128-7/1	SHEET 1 of 1
					REVISION I R		